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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

|                                 |   |
|---------------------------------|---|
| Product Status                  | Obsolete  |
| Programmable Type               | In System Programmable  |
| Delay Time tpd(1) Max           | 15 ns   |
| Voltage Supply - Internal       | 4.75V ~ 5.25V   |
| Number of Logic Elements/Blocks | 16  |
| Number of Macrocells            | 256   |
| Number of Gates                 | 5000  |
| Number of I/O                   | 164   |
| Operating Temperature           | 0°C ~ 70°C (TA)   |
| Mounting Type                   | Surface Mount   |
| Package / Case                  | 208-BFQFP   |
| Supplier Device Package         | 208-PQFP (28x28)  |
| Purchase URL                    | <a href="https://www.e-xfl.com/product-detail/intel/epm7256sqc208-15">https://www.e-xfl.com/product-detail/intel/epm7256sqc208-15</a> |

The MAX 7000E devices—including the EPM7128E, EPM7160E, EPM7192E, and EPM7256E devices—have several enhanced features: additional global clocking, additional output enable controls, enhanced interconnect resources, fast input registers, and a programmable slew rate.

In-system programmable MAX 7000 devices—called MAX 7000S devices—include the EPM7032S, EPM7064S, EPM7128S, EPM7160S, EPM7192S, and EPM7256S devices. MAX 7000S devices have the enhanced features of MAX 7000E devices as well as JTAG BST circuitry in devices with 128 or more macrocells, ISP, and an open-drain output option. See [Table 4](#).

| <b>Table 4. MAX 7000 Device Features</b> |  |                                      |                                      |
|--|--|--------------------------------------|--------------------------------------|
| <b>Feature</b>                           | <b>EPM7032<br/>EPM7064<br/>EPM7096</b> | <b>All<br/>MAX 7000E<br/>Devices</b> | <b>All<br/>MAX 7000S<br/>Devices</b> |
| ISP via JTAG interface                   |  |                                      | ✓                                    |
| JTAG BST circuitry                       |  |                                      | ✓ <sup>(1)</sup>                     |
| Open-drain output option                 |  |                                      | ✓                                    |
| Fast input registers                     |  | ✓                                    | ✓                                    |
| Six global output enables                |  | ✓                                    | ✓                                    |
| Two global clocks                        |  | ✓                                    | ✓                                    |
| Slew-rate control                        |  | ✓                                    | ✓                                    |
| MultiVolt interface <sup>(2)</sup>       | ✓                                      | ✓                                    | ✓                                    |
| Programmable register                    | ✓                                      | ✓                                    | ✓                                    |
| Parallel expanders                       | ✓                                      | ✓                                    | ✓                                    |
| Shared expanders                         | ✓                                      | ✓                                    | ✓                                    |
| Power-saving mode                        | ✓                                      | ✓                                    | ✓                                    |
| Security bit                             | ✓                                      | ✓                                    | ✓                                    |
| PCI-compliant devices available          | ✓                                      | ✓                                    | ✓                                    |

**Notes:**

- (1) Available only in EPM7128S, EPM7160S, EPM7192S, and EPM7256S devices only.
- (2) The MultiVolt I/O interface is not available in 44-pin packages.

The MAX 7000 architecture supports 100% TTL emulation and high-density integration of SSI, MSI, and LSI logic functions. The MAX 7000 architecture easily integrates multiple devices ranging from PALs, GALs, and 22V10s to MACH and pLSI devices. MAX 7000 devices are available in a wide range of packages, including PLCC, PGA, PQFP, RQFP, and TQFP packages. See [Table 5](#).

**Table 5. MAX 7000 Maximum User I/O Pins** *Note (1)*

| Device   | 44-Pin<br>PLCC | 44-Pin<br>PQFP | 44-Pin<br>TQFP | 68-Pin<br>PLCC | 84-Pin<br>PLCC | 100-Pin<br>PQFP | 100-Pin<br>TQFP | 160-Pin<br>PQFP | 160-Pin<br>PGA | 192-Pin<br>PGA | 208-Pin<br>PQFP | 208-Pin<br>RQFP |
|----------|----------------|----------------|----------------|----------------|----------------|-----------------|-----------------|-----------------|----------------|----------------|-----------------|-----------------|
| EPM7032  | 36             | 36             | 36             |                |                |                 |                 |                 |                |                |                 |                 |
| EPM7032S | 36             |                | 36             |                |                |                 |                 |                 |                |                |                 |                 |
| EPM7064  | 36             |                | 36             | 52             | 68             | 68              |                 |                 |                |                |                 |                 |
| EPM7064S | 36             |                | 36             |                | 68             | 68              |                 |                 |                |                |                 |                 |
| EPM7096  |                |                |                | 52             | 64             | 76              |                 |                 |                |                |                 |                 |
| EPM7128E |                |                |                |                | 68             | 84              |                 | 100             |                |                |                 |                 |
| EPM7128S |                |                |                |                | 68             | 84              | 84 (2)          | 100             |                |                |                 |                 |
| EPM7160E |                |                |                |                | 64             | 84              |                 | 104             |                |                |                 |                 |
| EPM7160S |                |                |                |                | 64             |                 | 84 (2)          | 104             |                |                |                 |                 |
| EPM7192E |                |                |                |                |                |                 |                 | 124             | 124            |                |                 |                 |
| EPM7192S |                |                |                |                |                |                 |                 | 124             |                |                |                 |                 |
| EPM7256E |                |                |                |                |                |                 |                 | 132 (2)         |                | 164            |                 | 164             |
| EPM7256S |                |                |                |                |                |                 |                 |                 |                |                | 164 (2)         | 164             |

**Notes:**

- (1) When the JTAG interface in MAX 7000S devices is used for either boundary-scan testing or for ISP, four I/O pins become JTAG pins.
- (2) Perform a complete thermal analysis before committing a design to this device package. For more information, see the [Operating Requirements for Altera Devices Data Sheet](#).

MAX 7000 devices use CMOS EEPROM cells to implement logic functions. The user-configurable MAX 7000 architecture accommodates a variety of independent combinatorial and sequential logic functions. The devices can be reprogrammed for quick and efficient iterations during design development and debug cycles, and can be programmed and erased up to 100 times.

MAX 7000 devices contain from 32 to 256 macrocells that are combined into groups of 16 macrocells, called logic array blocks (LABs). Each macrocell has a programmable-AND/fixed-OR array and a configurable register with independently programmable clock, clock enable, clear, and preset functions. To build complex logic functions, each macrocell can be supplemented with both shareable expander product terms and high-speed parallel expander product terms to provide up to 32 product terms per macrocell.

The MAX 7000 family provides programmable speed/power optimization. Speed-critical portions of a design can run at high speed/full power, while the remaining portions run at reduced speed/low power. This speed/power optimization feature enables the designer to configure one or more macrocells to operate at 50% or lower power while adding only a nominal timing delay. MAX 7000E and MAX 7000S devices also provide an option that reduces the slew rate of the output buffers, minimizing noise transients when non-speed-critical signals are switching. The output drivers of all MAX 7000 devices (except 44-pin devices) can be set for either 3.3-V or 5.0-V operation, allowing MAX 7000 devices to be used in mixed-voltage systems.

The MAX 7000 family is supported by Altera development systems, which are integrated packages that offer schematic, text—including VHDL, Verilog HDL, and the Altera Hardware Description Language (AHDL)—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The software provides EDIF 2.0.0 and 3.0.0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX-workstation-based EDA tools. The software runs on Windows-based PCs, as well as Sun SPARCstation, and HP 9000 Series 700/800 workstations.



For more information on development tools, see the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet* and the *Quartus Programmable Logic Development System & Software Data Sheet*.

## Functional Description

The MAX 7000 architecture includes the following elements:

- Logic array blocks
- Macrocells
- Expander product terms (shareable and parallel)
- Programmable interconnect array
- I/O control blocks

Each programmable register can be clocked in three different modes:

- By a global clock signal. This mode achieves the fastest clock-to-output performance.
- By a global clock signal and enabled by an active-high clock enable. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- By an array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

In EPM7032, EPM7064, and EPM7096 devices, the global clock signal is available from a dedicated clock pin, GCLK1, as shown in [Figure 1](#). In MAX 7000E and MAX 7000S devices, two global clock signals are available. As shown in [Figure 2](#), these global clock signals can be the true or the complement of either of the global clock pins, GCLK1 or GCLK2.

Each register also supports asynchronous preset and clear functions. As shown in [Figures 3 and 4](#), the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear of the register are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the active-low dedicated global clear pin (GCLRn). Upon power-up, each register in the device will be set to a low state.

All MAX 7000E and MAX 7000S I/O pins have a fast input path to a macrocell register. This dedicated path allows a signal to bypass the PIA and combinatorial logic and be driven to an input D flipflop with an extremely fast (2.5 ns) input setup time.

## Expander Product Terms

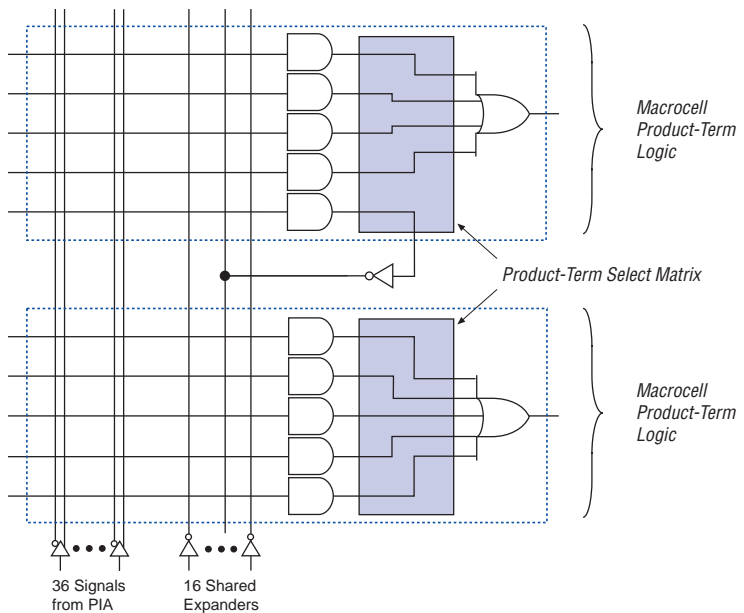
Although most logic functions can be implemented with the five product terms available in each macrocell, the more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources; however, the MAX 7000 architecture also allows both shareable and parallel expander product terms (“expanders”) that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

### Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay ( $t_{SEXP}$ ) is incurred when shareable expanders are used. Figure 5 shows how shareable expanders can feed multiple macrocells.

**Figure 5. Shareable Expanders**

Shareable expanders can be shared by any or all macrocells in an LAB.



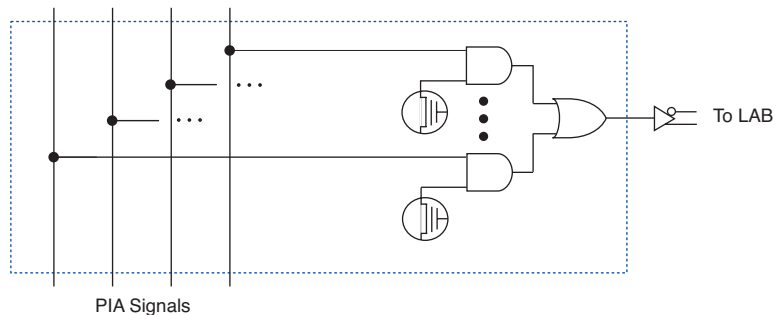
### Parallel Expanders

Parallel expanders are unused product terms that can be allocated to a neighboring macrocell to implement fast, complex logic functions. Parallel expanders allow up to 20 product terms to directly feed the macrocell OR logic, with five product terms provided by the macrocell and 15 parallel expanders provided by neighboring macrocells in the LAB.

## Programmable Interconnect Array

Logic is routed between LABs via the programmable interconnect array (PIA). This global bus is a programmable path that connects any signal source to any destination on the device. All MAX 7000 dedicated inputs, I/O pins, and macrocell outputs feed the PIA, which makes the signals available throughout the entire device. Only the signals required by each LAB are actually routed from the PIA into the LAB. Figure 7 shows how the PIA signals are routed into the LAB. An EEPROM cell controls one input to a 2-input AND gate, which selects a PIA signal to drive into the LAB.

**Figure 7. PIA Routing**



While the routing delays of channel-based routing schemes in masked or FPGAs are cumulative, variable, and path-dependent, the MAX 7000 PIA has a fixed delay. The PIA thus eliminates skew between signals and makes timing performance easy to predict.

## I/O Control Blocks

The I/O control block allows each I/O pin to be individually configured for input, output, or bidirectional operation. All I/O pins have a tri-state buffer that is individually controlled by one of the global output enable signals or directly connected to ground or  $V_{CC}$ . Figure 8 shows the I/O control block for the MAX 7000 family. The I/O control block of EPM7032, EPM7064, and EPM7096 devices has two global output enable signals that are driven by two dedicated active-low output enable pins (OE1 and OE2). The I/O control block of MAX 7000E and MAX 7000S devices has six global output enable signals that are driven by the true or complement of two output enable signals, a subset of the I/O pins, or a subset of the I/O macrocells.

The programming times described in Tables 6 through 8 are associated with the worst-case method using the enhanced ISP algorithm.

**Table 6. MAX 7000S  $t_{PULSE}$  &  $Cycle_{TCK}$  Values**

| Device   | Programming     |                | Stand-Alone Verification |                |
|----------|-----------------|----------------|--------------------------|----------------|
|          | $t_{PULSE}$ (s) | $Cycle_{PTCK}$ | $t_{VPULSE}$ (s)         | $Cycle_{VTCK}$ |
| EPM7032S | 4.02            | 342,000        | 0.03                     | 200,000        |
| EPM7064S | 4.50            | 504,000        | 0.03                     | 308,000        |
| EPM7128S | 5.11            | 832,000        | 0.03                     | 528,000        |
| EPM7160S | 5.35            | 1,001,000      | 0.03                     | 640,000        |
| EPM7192S | 5.71            | 1,192,000      | 0.03                     | 764,000        |
| EPM7256S | 6.43            | 1,603,000      | 0.03                     | 1,024,000      |

Tables 7 and 8 show the in-system programming and stand alone verification times for several common test clock frequencies.

**Table 7. MAX 7000S In-System Programming Times for Different Test Clock Frequencies**

| Device   | $f_{TCK}$ |       |       |       |         |         |         |        | Units |
|----------|-----------|-------|-------|-------|---------|---------|---------|--------|-------|
|          | 10 MHz    | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz |       |
| EPM7032S | 4.06      | 4.09  | 4.19  | 4.36  | 4.71    | 5.73    | 7.44    | 10.86  | s     |
| EPM7064S | 4.55      | 4.60  | 4.76  | 5.01  | 5.51    | 7.02    | 9.54    | 14.58  | s     |
| EPM7128S | 5.19      | 5.27  | 5.52  | 5.94  | 6.77    | 9.27    | 13.43   | 21.75  | s     |
| EPM7160S | 5.45      | 5.55  | 5.85  | 6.35  | 7.35    | 10.35   | 15.36   | 25.37  | s     |
| EPM7192S | 5.83      | 5.95  | 6.30  | 6.90  | 8.09    | 11.67   | 17.63   | 29.55  | s     |
| EPM7256S | 6.59      | 6.75  | 7.23  | 8.03  | 9.64    | 14.45   | 22.46   | 38.49  | s     |

**Table 8. MAX 7000S Stand-Alone Verification Times for Different Test Clock Frequencies**

| Device   | $f_{TCK}$ |       |       |       |         |         |         |        | Units |
|----------|-----------|-------|-------|-------|---------|---------|---------|--------|-------|
|          | 10 MHz    | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz |       |
| EPM7032S | 0.05      | 0.07  | 0.13  | 0.23  | 0.43    | 1.03    | 2.03    | 4.03   | s     |
| EPM7064S | 0.06      | 0.09  | 0.18  | 0.34  | 0.64    | 1.57    | 3.11    | 6.19   | s     |
| EPM7128S | 0.08      | 0.14  | 0.29  | 0.56  | 1.09    | 2.67    | 5.31    | 10.59  | s     |
| EPM7160S | 0.09      | 0.16  | 0.35  | 0.67  | 1.31    | 3.23    | 6.43    | 12.83  | s     |
| EPM7192S | 0.11      | 0.18  | 0.41  | 0.79  | 1.56    | 3.85    | 7.67    | 15.31  | s     |
| EPM7256S | 0.13      | 0.24  | 0.54  | 1.06  | 2.08    | 5.15    | 10.27   | 20.51  | s     |



## Design Security

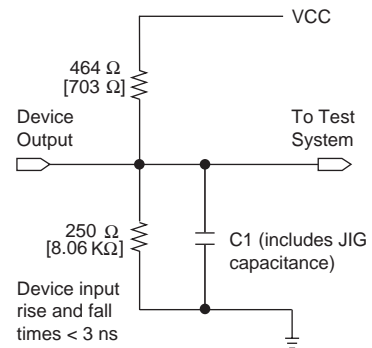
All MAX 7000 devices contain a programmable security bit that controls access to the data programmed into the device. When this bit is programmed, a proprietary design implemented in the device cannot be copied or retrieved. This feature provides a high level of design security because programmed data within EEPROM cells is invisible. The security bit that controls this function, as well as all other programmed data, is reset only when the device is reprogrammed.

## Generic Testing

Each MAX 7000 device is functionally tested. Complete testing of each programmable EEPROM bit and all internal logic elements ensures 100% programming yield. AC test measurements are taken under conditions equivalent to those shown in [Figure 10](#). Test patterns can be used and then erased during early stages of the production flow.

**Figure 10. MAX 7000 AC Test Conditions**

*Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in brackets are for 2.5-V devices and outputs. Numbers without brackets are for 3.3-V devices and outputs.*



## QFP Carrier & Development Socket

MAX 7000 and MAX 7000E devices in QFP packages with 100 or more pins are shipped in special plastic carriers to protect the QFP leads. The carrier is used with a prototype development socket and special programming hardware available from Altera. This carrier technology makes it possible to program, test, erase, and reprogram a device without exposing the leads to mechanical stress.



For detailed information and carrier dimensions, refer to the [QFP Carrier & Development Socket Data Sheet](#).



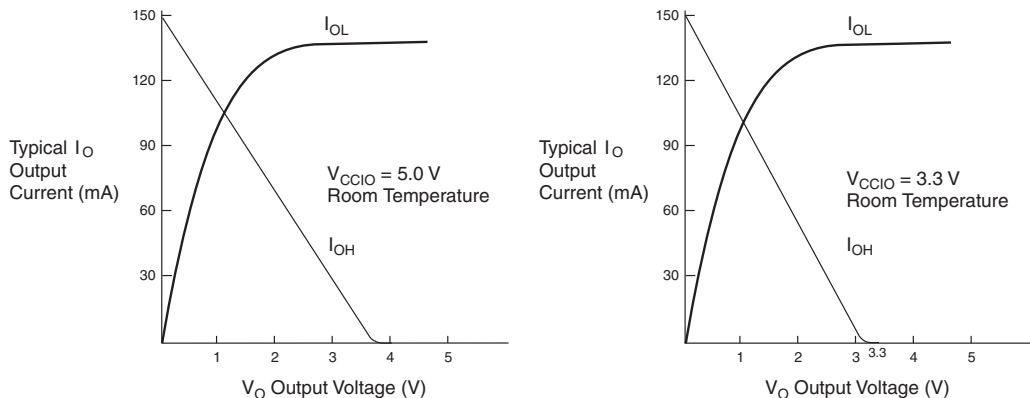
MAX 7000S devices are not shipped in carriers.

## Notes to tables:

- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input voltage on I/O pins is  $-0.5$  V and on 4 dedicated input pins is  $-0.3$  V. During transitions, the inputs may undershoot to  $-2.0$  V or overshoot to  $7.0$  V for input currents less than  $100$  mA and periods shorter than  $20$  ns.
- (3) Numbers in parentheses are for industrial-temperature-range devices.
- (4)  $V_{CC}$  must rise monotonically.
- (5) The POR time for all 7000S devices does not exceed  $300$   $\mu$ s. The sufficient  $V_{CCINT}$  voltage level for POR is  $4.5$  V. The device is fully initialized within the POR time after  $V_{CCINT}$  reaches the sufficient POR voltage level.
- (6)  $3.3$ -V I/O operation is not available for 44-pin packages.
- (7) The  $V_{CCISP}$  parameter applies only to MAX 7000S devices.
- (8) During in-system programming, the minimum DC input voltage is  $-0.3$  V.
- (9) These values are specified under the MAX 7000 recommended operating conditions in [Table 14 on page 26](#).
- (10) The parameter is measured with 50% of the outputs each sourcing the specified current. The  $I_{OH}$  parameter refers to high-level TTL or CMOS output current.
- (11) The parameter is measured with 50% of the outputs each sinking the specified current. The  $I_{OL}$  parameter refers to low-level TTL, PCI, or CMOS output current.
- (12) When the JTAG interface is enabled in MAX 7000S devices, the input leakage current on the JTAG pins is typically  $-60$   $\mu$ A.
- (13) Capacitance is measured at  $25^\circ$  C and is sample-tested only. The  $\text{OE}1$  pin has a maximum capacitance of  $20$  pF.

Figure 11 shows the typical output drive characteristics of MAX 7000 devices.

**Figure 11. Output Drive Characteristics of 5.0-V MAX 7000 Devices**



## Timing Model

MAX 7000 device timing can be analyzed with the Altera software, with a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in [Figure 12](#). MAX 7000 devices have fixed internal delays that enable the designer to determine the worst-case timing of any design. The Altera software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for a device-wide performance evaluation.

**Table 21. MAX 7000 & MAX 7000E External Timing Parameters** *Note (1)*

| Symbol            | Parameter                                | Conditions     | Speed Grade      |      |                                   |      | Unit |
|-------------------|--|----------------|------------------|------|-----------------------------------|------|------|
|                   |  |                | MAX 7000E (-10P) |      | MAX 7000 (-10)<br>MAX 7000E (-10) |      |      |
|                   |  |                | Min              | Max  | Min                               | Max  |      |
| t <sub>PD1</sub>  | Input to non-registered output           | C1 = 35 pF     |                  | 10.0 |                                   | 10.0 | ns   |
| t <sub>PD2</sub>  | I/O input to non-registered output       | C1 = 35 pF     |                  | 10.0 |                                   | 10.0 | ns   |
| t <sub>SU</sub>   | Global clock setup time                  |                | 7.0              |      | 8.0                               |      | ns   |
| t <sub>H</sub>    | Global clock hold time                   |                | 0.0              |      | 0.0                               |      | ns   |
| t <sub>FSU</sub>  | Global clock setup time of fast input    | (2)            | 3.0              |      | 3.0                               |      | ns   |
| t <sub>FH</sub>   | Global clock hold time of fast input     | (2)            | 0.5              |      | 0.5                               |      | ns   |
| t <sub>CO1</sub>  | Global clock to output delay             | C1 = 35 pF     |                  | 5.0  |                                   | 5    | ns   |
| t <sub>CH</sub>   | Global clock high time                   |                | 4.0              |      | 4.0                               |      | ns   |
| t <sub>CL</sub>   | Global clock low time                    |                | 4.0              |      | 4.0                               |      | ns   |
| t <sub>ASU</sub>  | Array clock setup time                   |                | 2.0              |      | 3.0                               |      | ns   |
| t <sub>AH</sub>   | Array clock hold time                    |                | 3.0              |      | 3.0                               |      | ns   |
| t <sub>ACO1</sub> | Array clock to output delay              | C1 = 35 pF     |                  | 10.0 |                                   | 10.0 | ns   |
| t <sub>ACH</sub>  | Array clock high time                    |                | 4.0              |      | 4.0                               |      | ns   |
| t <sub>ACL</sub>  | Array clock low time                     |                | 4.0              |      | 4.0                               |      | ns   |
| t <sub>CPPW</sub> | Minimum pulse width for clear and preset | (3)            | 4.0              |      | 4.0                               |      | ns   |
| t <sub>ODH</sub>  | Output data hold time after clock        | C1 = 35 pF (4) | 1.0              |      | 1.0                               |      | ns   |
| t <sub>CNT</sub>  | Minimum global clock period              |                |                  | 10.0 |                                   | 10.0 | ns   |
| f <sub>CNT</sub>  | Maximum internal global clock frequency  | (5)            | 100.0            |      | 100.0                             |      | MHz  |
| t <sub>ACNT</sub> | Minimum array clock period               |                |                  | 10.0 |                                   | 10.0 | ns   |
| f <sub>ACNT</sub> | Maximum internal array clock frequency   | (5)            | 100.0            |      | 100.0                             |      | MHz  |
| f <sub>MAX</sub>  | Maximum clock frequency                  | (6)            | 125.0            |      | 125.0                             |      | MHz  |

**Table 22. MAX 7000 & MAX 7000E Internal Timing Parameters** *Note (1)*

| Symbol     | Parameter   | Conditions       | Speed Grade      |      |                                   |      | Unit |
|------------|---|------------------|------------------|------|-----------------------------------|------|------|
|            |   |                  | MAX 7000E (-10P) |      | MAX 7000 (-10)<br>MAX 7000E (-10) |      |      |
|            |   |                  | Min              | Max  | Min                               | Max  |      |
| $t_{IN}$   | Input pad and buffer delay  |                  |                  | 0.5  |                                   | 1.0  | ns   |
| $t_{IO}$   | I/O input pad and buffer delay  |                  |                  | 0.5  |                                   | 1.0  | ns   |
| $t_{FIN}$  | Fast input delay  | (2)              |                  | 1.0  |                                   | 1.0  | ns   |
| $t_{SEXP}$ | Shared expander delay   |                  |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{PEXP}$ | Parallel expander delay   |                  |                  | 0.8  |                                   | 0.8  | ns   |
| $t_{LAD}$  | Logic array delay   |                  |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{LAC}$  | Logic control array delay   |                  |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{IOE}$  | Internal output enable delay  | (2)              |                  | 2.0  |                                   | 2.0  | ns   |
| $t_{OD1}$  | Output buffer and pad delay<br>Slow slew rate = off<br>$V_{CCIO} = 5.0$ V         | $C1 = 35$ pF     |                  | 1.5  |                                   | 2.0  | ns   |
| $t_{OD2}$  | Output buffer and pad delay<br>Slow slew rate = off<br>$V_{CCIO} = 3.3$ V         | $C1 = 35$ pF (7) |                  | 2.0  |                                   | 2.5  | ns   |
| $t_{OD3}$  | Output buffer and pad delay<br>Slow slew rate = on<br>$V_{CCIO} = 5.0$ V or 3.3 V | $C1 = 35$ pF (2) |                  | 5.5  |                                   | 6.0  | ns   |
| $t_{ZX1}$  | Output buffer enable delay<br>Slow slew rate = off<br>$V_{CCIO} = 5.0$ V          | $C1 = 35$ pF     |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{ZX2}$  | Output buffer enable delay<br>Slow slew rate = off<br>$V_{CCIO} = 3.3$ V          | $C1 = 35$ pF (7) |                  | 5.5  |                                   | 5.5  | ns   |
| $t_{ZX3}$  | Output buffer enable delay<br>Slow slew rate = on<br>$V_{CCIO} = 5.0$ V or 3.3 V  | $C1 = 35$ pF (2) |                  | 9.0  |                                   | 9.0  | ns   |
| $t_{XZ}$   | Output buffer disable delay   | $C1 = 5$ pF      |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{SU}$   | Register setup time   |                  | 2.0              |      | 3.0                               |      | ns   |
| $t_H$      | Register hold time  |                  | 3.0              |      | 3.0                               |      | ns   |
| $t_{FSU}$  | Register setup time of fast input   | (2)              | 3.0              |      | 3.0                               |      | ns   |
| $t_{FH}$   | Register hold time of fast input  | (2)              | 0.5              |      | 0.5                               |      | ns   |
| $t_{RD}$   | Register delay  |                  |                  | 2.0  |                                   | 1.0  | ns   |
| $t_{COMB}$ | Combinatorial delay   |                  |                  | 2.0  |                                   | 1.0  | ns   |
| $t_{IC}$   | Array clock delay   |                  |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{EN}$   | Register enable time  |                  |                  | 5.0  |                                   | 5.0  | ns   |
| $t_{GLOB}$ | Global control delay  |                  |                  | 1.0  |                                   | 1.0  | ns   |
| $t_{PRE}$  | Register preset time  |                  |                  | 3.0  |                                   | 3.0  | ns   |
| $t_{CLR}$  | Register clear time   |                  |                  | 3.0  |                                   | 3.0  | ns   |
| $t_{PIA}$  | PIA delay   |                  |                  | 1.0  |                                   | 1.0  | ns   |
| $t_{LPA}$  | Low-power adder   | (8)              |                  | 11.0 |                                   | 11.0 | ns   |

**Table 26. MAX 7000 & MAX 7000E Internal Timing Parameters** *Note (1)*

| Symbol     | Parameter   | Conditions              | Speed Grade |      |      |      |     |      | Unit |
|------------|---|-------------------------|-------------|------|------|------|-----|------|------|
|            |   |                         | -15         |      | -15T |      | -20 |      |      |
|            |   |                         | Min         | Max  | Min  | Max  | Min | Max  |      |
| $t_{IN}$   | Input pad and buffer delay  |                         |             | 2.0  |      | 2.0  |     | 3.0  | ns   |
| $t_{IO}$   | I/O input pad and buffer delay  |                         |             | 2.0  |      | 2.0  |     | 3.0  | ns   |
| $t_{FIN}$  | Fast input delay  | (2)                     |             | 2.0  |      | —    |     | 4.0  | ns   |
| $t_{SEXP}$ | Shared expander delay   |                         |             | 8.0  |      | 10.0 |     | 9.0  | ns   |
| $t_{PEXP}$ | Parallel expander delay   |                         |             | 1.0  |      | 1.0  |     | 2.0  | ns   |
| $t_{LAD}$  | Logic array delay   |                         |             | 6.0  |      | 6.0  |     | 8.0  | ns   |
| $t_{LAC}$  | Logic control array delay   |                         |             | 6.0  |      | 6.0  |     | 8.0  | ns   |
| $t_{IOE}$  | Internal output enable delay  | (2)                     |             | 3.0  |      | —    |     | 4.0  | ns   |
| $t_{OD1}$  | Output buffer and pad delay<br>Slow slew rate = off<br>$V_{CCIO} = 5.0\text{ V}$                  | $C1 = 35\text{ pF}$     |             | 4.0  |      | 4.0  |     | 5.0  | ns   |
| $t_{OD2}$  | Output buffer and pad delay<br>Slow slew rate = off<br>$V_{CCIO} = 3.3\text{ V}$                  | $C1 = 35\text{ pF}$ (7) |             | 5.0  |      | —    |     | 6.0  | ns   |
| $t_{OD3}$  | Output buffer and pad delay<br>Slow slew rate = on<br>$V_{CCIO} = 5.0\text{ V}$ or $3.3\text{ V}$ | $C1 = 35\text{ pF}$ (2) |             | 8.0  |      | —    |     | 9.0  | ns   |
| $t_{ZX1}$  | Output buffer enable delay<br>Slow slew rate = off<br>$V_{CCIO} = 5.0\text{ V}$                   | $C1 = 35\text{ pF}$     |             | 6.0  |      | 6.0  |     | 10.0 | ns   |
| $t_{ZX2}$  | Output buffer enable delay<br>Slow slew rate = off<br>$V_{CCIO} = 3.3\text{ V}$                   | $C1 = 35\text{ pF}$ (7) |             | 7.0  |      | —    |     | 11.0 | ns   |
| $t_{ZX3}$  | Output buffer enable delay<br>Slow slew rate = on<br>$V_{CCIO} = 5.0\text{ V}$ or $3.3\text{ V}$  | $C1 = 35\text{ pF}$ (2) |             | 10.0 |      | —    |     | 14.0 | ns   |
| $t_{XZ}$   | Output buffer disable delay   | $C1 = 5\text{ pF}$      |             | 6.0  |      | 6.0  |     | 10.0 | ns   |
| $t_{SU}$   | Register setup time   |                         | 4.0         |      | 4.0  |      | 4.0 |      | ns   |
| $t_H$      | Register hold time  |                         | 4.0         |      | 4.0  |      | 5.0 |      | ns   |
| $t_{FSU}$  | Register setup time of fast input   | (2)                     | 2.0         |      | —    |      | 4.0 |      | ns   |
| $t_{FH}$   | Register hold time of fast input  | (2)                     | 2.0         |      | —    |      | 3.0 |      | ns   |
| $t_{RD}$   | Register delay  |                         |             | 1.0  |      | 1.0  |     | 1.0  | ns   |
| $t_{COMB}$ | Combinatorial delay   |                         |             | 1.0  |      | 1.0  |     | 1.0  | ns   |
| $t_{IC}$   | Array clock delay   |                         |             | 6.0  |      | 6.0  |     | 8.0  | ns   |
| $t_{EN}$   | Register enable time  |                         |             | 6.0  |      | 6.0  |     | 8.0  | ns   |
| $t_{GLOB}$ | Global control delay  |                         |             | 1.0  |      | 1.0  |     | 3.0  | ns   |
| $t_{PRE}$  | Register preset time  |                         |             | 4.0  |      | 4.0  |     | 4.0  | ns   |
| $t_{CLR}$  | Register clear time   |                         |             | 4.0  |      | 4.0  |     | 4.0  | ns   |
| $t_{PIA}$  | PIA delay   |                         |             | 2.0  |      | 2.0  |     | 3.0  | ns   |
| $t_{LPA}$  | Low-power adder   | (8)                     |             | 13.0 |      | 15.0 |     | 15.0 | ns   |

**Table 27. EPM7032S External Timing Parameters (Part 2 of 2)** *Note (1)*

| Symbol            | Parameter                              | Conditions | Speed Grade |     |       |     |       |     |       |     | Unit |
|-------------------|--|------------|-------------|-----|-------|-----|-------|-----|-------|-----|------|
|                   |  |            | -5          |     | -6    |     | -7    |     | -10   |     |      |
|                   |  |            | Min         | Max | Min   | Max | Min   | Max | Min   | Max |      |
| f <sub>ACNT</sub> | Maximum internal array clock frequency | (4)        | 175.4       |     | 142.9 |     | 116.3 |     | 100.0 |     | MHz  |
| f <sub>MAX</sub>  | Maximum clock frequency                | (5)        | 250.0       |     | 200.0 |     | 166.7 |     | 125.0 |     | MHz  |

**Table 28. EPM7032S Internal Timing Parameters** *Note (1)*

| Symbol     | Parameter                         | Conditions     | Speed Grade |     |     |     |     |     |     |     | Unit |
|------------|-----------------------------------|----------------|-------------|-----|-----|-----|-----|-----|-----|-----|------|
|            |                                   |                | -5          |     | -6  |     | -7  |     | -10 |     |      |
|            |                                   |                | Min         | Max | Min | Max | Min | Max | Min | Max |      |
| $t_{IN}$   | Input pad and buffer delay        |                |             | 0.2 |     | 0.2 |     | 0.3 |     | 0.5 | ns   |
| $t_{IO}$   | I/O input pad and buffer delay    |                |             | 0.2 |     | 0.2 |     | 0.3 |     | 0.5 | ns   |
| $t_{FIN}$  | Fast input delay                  |                |             | 2.2 |     | 2.1 |     | 2.5 |     | 1.0 | ns   |
| $t_{SEXP}$ | Shared expander delay             |                |             | 3.1 |     | 3.8 |     | 4.6 |     | 5.0 | ns   |
| $t_{PEXP}$ | Parallel expander delay           |                |             | 0.9 |     | 1.1 |     | 1.4 |     | 0.8 | ns   |
| $t_{LAD}$  | Logic array delay                 |                |             | 2.6 |     | 3.3 |     | 4.0 |     | 5.0 | ns   |
| $t_{LAC}$  | Logic control array delay         |                |             | 2.5 |     | 3.3 |     | 4.0 |     | 5.0 | ns   |
| $t_{IOE}$  | Internal output enable delay      |                |             | 0.7 |     | 0.8 |     | 1.0 |     | 2.0 | ns   |
| $t_{OD1}$  | Output buffer and pad delay       | C1 = 35 pF     |             | 0.2 |     | 0.3 |     | 0.4 |     | 1.5 | ns   |
| $t_{OD2}$  | Output buffer and pad delay       | C1 = 35 pF (6) |             | 0.7 |     | 0.8 |     | 0.9 |     | 2.0 | ns   |
| $t_{OD3}$  | Output buffer and pad delay       | C1 = 35 pF     |             | 5.2 |     | 5.3 |     | 5.4 |     | 5.5 | ns   |
| $t_{ZX1}$  | Output buffer enable delay        | C1 = 35 pF     |             | 4.0 |     | 4.0 |     | 4.0 |     | 5.0 | ns   |
| $t_{ZX2}$  | Output buffer enable delay        | C1 = 35 pF (6) |             | 4.5 |     | 4.5 |     | 4.5 |     | 5.5 | ns   |
| $t_{ZX3}$  | Output buffer enable delay        | C1 = 35 pF     |             | 9.0 |     | 9.0 |     | 9.0 |     | 9.0 | ns   |
| $t_{XZ}$   | Output buffer disable delay       | C1 = 5 pF      |             | 4.0 |     | 4.0 |     | 4.0 |     | 5.0 | ns   |
| $t_{SU}$   | Register setup time               |                | 0.8         |     | 1.0 |     | 1.3 |     | 2.0 |     | ns   |
| $t_H$      | Register hold time                |                | 1.7         |     | 2.0 |     | 2.5 |     | 3.0 |     | ns   |
| $t_{FSU}$  | Register setup time of fast input |                | 1.9         |     | 1.8 |     | 1.7 |     | 3.0 |     | ns   |
| $t_{FH}$   | Register hold time of fast input  |                | 0.6         |     | 0.7 |     | 0.8 |     | 0.5 |     | ns   |
| $t_{RD}$   | Register delay                    |                |             | 1.2 |     | 1.6 |     | 1.9 |     | 2.0 | ns   |
| $t_{COMB}$ | Combinatorial delay               |                |             | 0.9 |     | 1.1 |     | 1.4 |     | 2.0 | ns   |
| $t_{IC}$   | Array clock delay                 |                |             | 2.7 |     | 3.4 |     | 4.2 |     | 5.0 | ns   |
| $t_{EN}$   | Register enable time              |                |             | 2.6 |     | 3.3 |     | 4.0 |     | 5.0 | ns   |
| $t_{GLOB}$ | Global control delay              |                |             | 1.6 |     | 1.4 |     | 1.7 |     | 1.0 | ns   |
| $t_{PRE}$  | Register preset time              |                |             | 2.0 |     | 2.4 |     | 3.0 |     | 3.0 | ns   |
| $t_{CLR}$  | Register clear time               |                |             | 2.0 |     | 2.4 |     | 3.0 |     | 3.0 | ns   |

**Table 36. EPM7192S Internal Timing Parameters (Part 2 of 2)** *Note (1)*

| Symbol     | Parameter                         | Conditions | Speed Grade |      |     |      |     |      | Unit |
|------------|-----------------------------------|------------|-------------|------|-----|------|-----|------|------|
|            |                                   |            | -7          |      | -10 |      | -15 |      |      |
|            |                                   |            | Min         | Max  | Min | Max  | Min | Max  |      |
| $t_H$      | Register hold time                |            | 1.7         |      | 3.0 |      | 4.0 |      | ns   |
| $t_{FSU}$  | Register setup time of fast input |            | 2.3         |      | 3.0 |      | 2.0 |      | ns   |
| $t_{FH}$   | Register hold time of fast input  |            | 0.7         |      | 0.5 |      | 1.0 |      | ns   |
| $t_{RD}$   | Register delay                    |            |             | 1.4  |     | 2.0  |     | 1.0  | ns   |
| $t_{COMB}$ | Combinatorial delay               |            |             | 1.2  |     | 2.0  |     | 1.0  | ns   |
| $t_{IC}$   | Array clock delay                 |            |             | 3.2  |     | 5.0  |     | 6.0  | ns   |
| $t_{EN}$   | Register enable time              |            |             | 3.1  |     | 5.0  |     | 6.0  | ns   |
| $t_{GLOB}$ | Global control delay              |            |             | 2.5  |     | 1.0  |     | 1.0  | ns   |
| $t_{PRE}$  | Register preset time              |            |             | 2.7  |     | 3.0  |     | 4.0  | ns   |
| $t_{CLR}$  | Register clear time               |            |             | 2.7  |     | 3.0  |     | 4.0  | ns   |
| $t_{PIA}$  | PIA delay                         | (7)        |             | 2.4  |     | 1.0  |     | 2.0  | ns   |
| $t_{LPA}$  | Low-power adder                   | (8)        |             | 10.0 |     | 11.0 |     | 13.0 | ns   |

**Notes to tables:**

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The  $t_{LPA}$  parameter must be added to this minimum width if the clear or reset signal incorporates the  $t_{LAD}$  parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The  $f_{MAX}$  values represent the highest frequency for pipelined data.
- (6) Operating conditions:  $V_{CCIO} = 3.3\text{ V} \pm 10\%$  for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The  $t_{LPA}$  parameter must be added to the  $t_{LAD}$ ,  $t_{LAC}$ ,  $t_{IC}$ ,  $t_{EN}$ ,  $t_{SEXP}$ ,  $t_{ACL}$  and  $t_{CPW}$  parameters for macrocells running in the low-power mode.

**Notes to tables:**

- (1) These values are specified under the recommended operating conditions shown in [Table 14](#). See [Figure 13](#) for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The  $t_{LPA}$  parameter must be added to this minimum width if the clear or reset signal incorporates the  $t_{LAD}$  parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The  $f_{MAX}$  values represent the highest frequency for pipelined data.
- (6) Operating conditions:  $V_{CCIO} = 3.3 \text{ V} \pm 10\%$  for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The  $t_{LPA}$  parameter must be added to the  $t_{LAD}$ ,  $t_{LAC}$ ,  $t_{IC}$ ,  $t_{EN}$ ,  $t_{SEXP}$ ,  $t_{ACL}$ , and  $t_{CPTW}$  parameters for macrocells running in the low-power mode.

## Power Consumption

Supply power (P) versus frequency ( $f_{MAX}$  in MHz) for MAX 7000 devices is calculated with the following equation:

$$P = P_{INT} + P_{IO} = I_{CCINT} \times V_{CC} + P_{IO}$$

The  $P_{IO}$  value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in [Application Note 74 \(Evaluating Power for Altera Devices\)](#).

The  $I_{CCINT}$  value, which depends on the switching frequency and the application logic, is calculated with the following equation:

$$I_{CCINT} =$$

$$A \times MC_{TON} + B \times (MC_{DEV} - MC_{TON}) + C \times MC_{USED} \times f_{MAX} \times \text{tog}_{LC}$$

The parameters in this equation are shown below:

|                   |   |   |
|-------------------|---|---|
| $MC_{TON}$        | = | Number of macrocells with the Turbo Bit option turned on, as reported in the MAX+PLUS II Report File (.rpt) |
| $MC_{DEV}$        | = | Number of macrocells in the device  |
| $MC_{USED}$       | = | Total number of macrocells in the design, as reported in the MAX+PLUS II Report File (.rpt)                 |
| $f_{MAX}$         | = | Highest clock frequency to the device   |
| $\text{tog}_{LC}$ | = | Average ratio of logic cells toggling at each clock (typically 0.125)                                       |
| A, B, C           | = | Constants, shown in <a href="#">Table 39</a>  |



Figure 14.  $I_{CC}$  vs. Frequency for MAX 7000 Devices (Part 2 of 2)

EPM7128E



EPM7160E



EPM7192E



EPM7256E



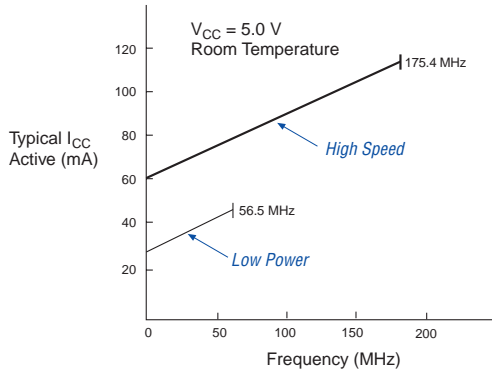
Figure 15 shows typical supply current versus frequency for MAX 7000S devices.

**Figure 15.  $I_{CC}$  vs. Frequency for MAX 7000S Devices (Part 1 of 2)**

**EPM7032S**



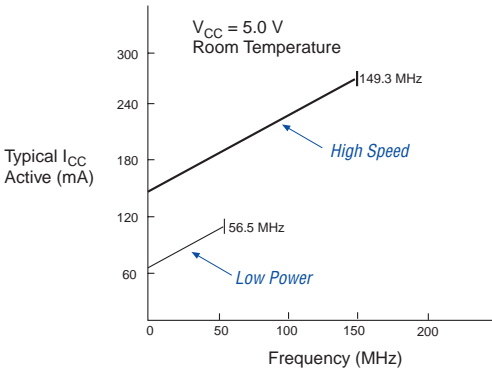
**EPM7064S**



**EPM7128S**



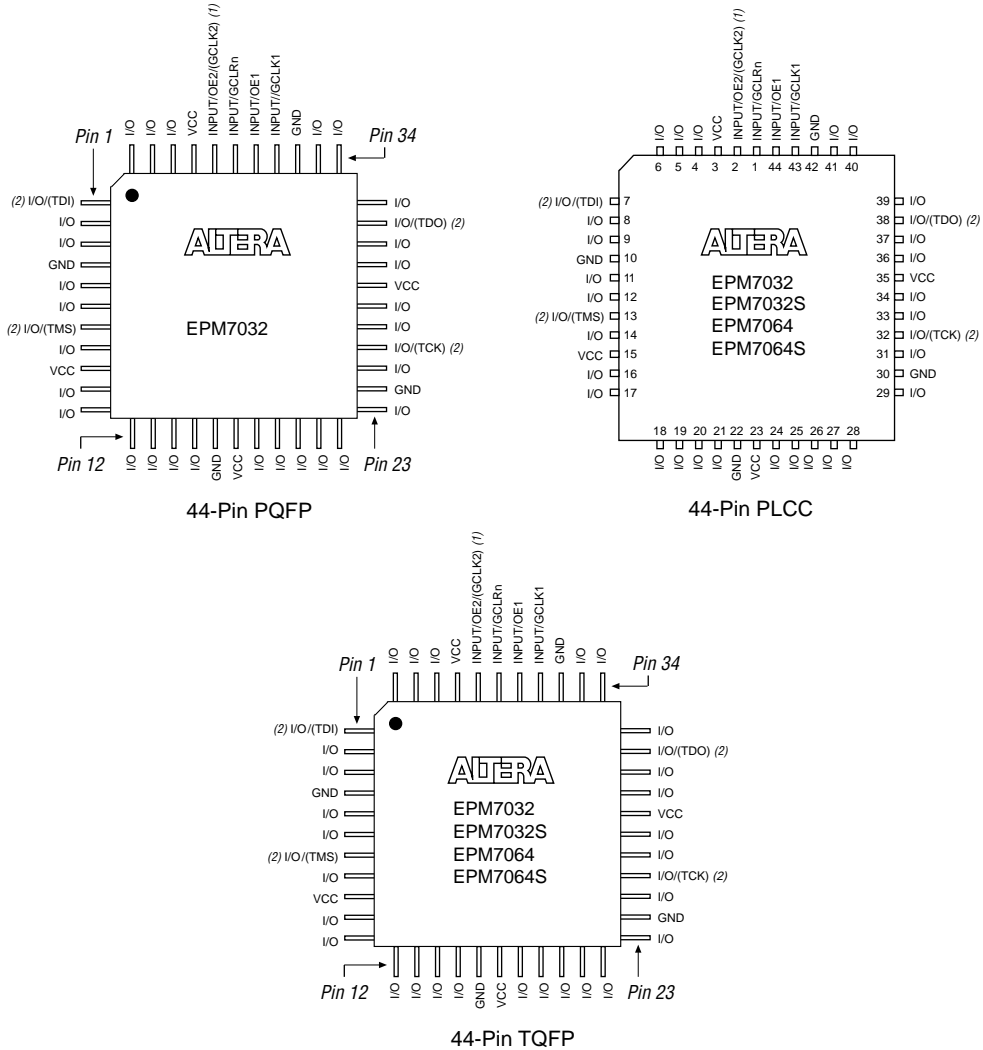
**EPM7160S**



Figures 16 through 22 show the package pin-out diagrams for MAX 7000 devices.

**Figure 16. 44-Pin Package Pin-Out Diagram**

Package outlines not drawn to scale.

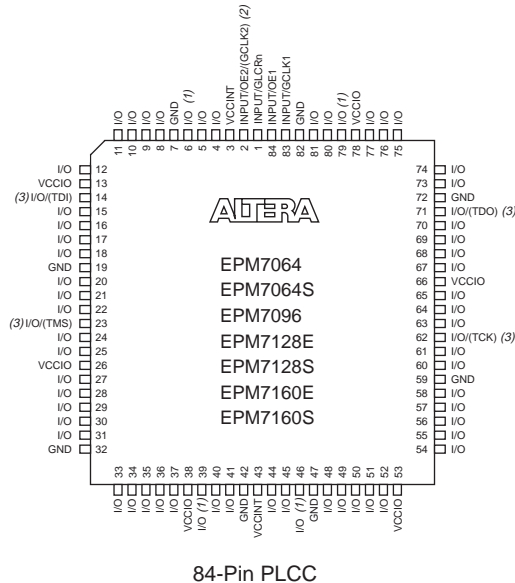


**Notes:**

- (1) The pin functions shown in parenthesis are only available in MAX 7000E and MAX 7000S devices.
- (2) JTAG ports are available in MAX 7000S devices only.

**Figure 18. 84-Pin Package Pin-Out Diagram**

Package outline not drawn to scale.



**Notes:**

- (1) Pins 6, 39, 46, and 79 are no-connect (N.C.) pins on EPM7096, EPM7160E, and EPM7160S devices.
- (2) The pin functions shown in parenthesis are only available in MAX 7000E and MAX 7000S devices.
- (3) JTAG ports are available in MAX 7000S devices only.



*Notes:*